

Overview

HP ProBook 455R G6 Notebook PC



Left

- | | |
|-----------------------------|---|
| 1. Internal Microphones (2) | 6. SD Card Reader |
| 2. Webcam | 7. Thermal Vent |
| 3. Webcam LED | 8. USB 2.0 Port |
| 4. Clickpad | 9. Standard Security Lock Slot (Lock sold separately) |
| 5. Hard Drive LED | 10. Power Button |

Overview



Right

- | | |
|-----------------------------------|---|
| 1. Power connector | 5. USB 3.1 Gen 1 port |
| 2. USB Type-C™ 3.1 Gen 1 port | 6. USB 3.1 Gen 1 port |
| 3. Ethernet port (RJ-45) | 7. Headphone/Microphone Combo Jack |
| 4. HDMI port (Cable not included) | 8. Optional HP Fingerprint Sensor (select models) |

Overview

At a Glance

- Preinstall Windows 10 or FreeDOS 3.0
- Choice of 2nd Generation AMD Ryzen™ processors
- Display include your choice of 39.62 cm (15.6") diagonal HD, Ultra Wide Viewing Angle FHD
- Integrated AMD Radeon™ Vega UMA Graphics
- Enhanced security features including TPM2.0, HP BIOSphere, Hardware enforced Firmware Protection, HP Fingerprint Sensor⁴ (select models) and optional IR camera³
- Passed 19 MIL-STD 810 G testing, plus an additional 120,000 hours of reliability testing through HP's Total Test Process¹
- Weight starting at 4.41 lbs (2 kgs)
- HP Long-Life Rechargeable batteries, with HP Fast Charge Technology recharges 50% in 30 minutes²
- Battery life Up to 13 hours and 45 minutes
- Supports wireless LAN
- Up to 512 GB Solid State Drives and 1 TB Hard Drive
- 32 GB total system memory
- 720 p HD webcam, IR camera for face authentication with Windows Hello
- Spill-resistant and optional backlit Keyboard with numeric keypad³, and Clickpad with multi-touch gestures enabled, taps enabled as default

1. MIL-STD-810G testing is not intended to demonstrate fitness of U.S. Department of Defense (DoD) contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.
2. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.
3. Sold separately or as an optional feature.
4. HP Fingerprint Sensor is an optional feature and requires configuration at purchase.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Technical Specifications

PRODUCT NAMES

HP ProBook 455R G6 Notebook PC

OPERATING SYSTEMS

| | |
|---------------------|--|
| Preinstalled | Windows 10 Pro 64 ¹ Windows 10 Pro 64 (National Academic only) ² Windows 10 Home 64 ¹ Windows 10 Home Single Language 64 ¹ FreeDOS 3.0 |
|---------------------|--|

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com/>.
2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see <https://aka.ms/ProEducation> for Windows 10 Pro Education feature information.

PROCESSORS

AMD Ryzen™ 7 PRO 3700U APU with Radeon™ Vega 10 Graphics (2.3 GHz base clock, up to 4 GHz max boost clock, 4 MB L3 cache, 4 cores)^{3,4,5,6}
AMD Ryzen™ 5 3500U APU with Radeon™ Vega 8 Graphics (2.1 GHz base clock, up to 3.7 GHz max boost clock, 4 MB cache, 4 cores)^{3,4,5,6}
AMD Ryzen™ 3 3300U APU with Radeon™ Vega 6 Graphics (2.1 GHz base clock, up to 3.5 GHz max boost clock, 4 MB cache, 4 cores)^{3,4,5,6}
AMD Ryzen™ 3 3200U APU with Radeon™ Vega 3 Graphics (2.6 GHz base clock, up to 3.5 GHz max boost clock, 4 MB cache, 2 cores)^{3,4,5,6}

Processors Family

AMD Ryzen™ APU processor⁶

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
5. Max Boost clock frequency performance varies depending on hardware, software and overall system configuration.
6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

Technical Specifications

CHIPSET

Integrated with processor

GRAPHICS

Integrated

Radeon™ Vega Graphics⁷

Supports

Support HD decode, DX12, HDMI 1.4b to 4K 30 Hz

[7. HD content required to view HD images.](#)

DISPLAYS

Non-Touch

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB, two WLAN antennas (1366 x 768) ^{7,8}

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD camera, one WLAN antenna (1366 x 768) ^{7,8}

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD camera, two WLAN antennas (1366 x 768) ^{7,8}

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD + IR camera, two WLAN antennas (1366 x 768) ^{7,8}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB, two WLAN antennas (1920 x 1080) ^{7,8}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD camera, one WLAN antenna (1920 x 1080) ^{7,8}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD camera, two WLAN antennas (1920 x 1080) ^{7,8}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD + IR camera, two WLAN antennas (1920 x 1080) ^{7,8}

Touch

Supports narrow bezel

HDMI

HDMI 1.4b, up to 4K 30Hz

[7. HD content required to view HD images.](#)

[8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.](#)

Technical Specifications

STORAGE AND DRIVES

Primary Storage

1 TB 5400 rpm SATA⁹
500 GB 7200 rpm SATA⁹

Primary M.2 Storage

128 GB SATA TLC Solid State Drive⁹
256 GB PCIe[®] NVMe[™] Value Solid State Drive⁹
512 GB PCIe[®] NVMe[™] TLC Solid State Drive⁹
512 GB PCIe[®] NVMe[™] Value Solid State Drive⁹

Note: PCIe SSD not available for Celeron

9. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

MEMORY

Maximum Memory

32 GB DDR4-2400 SDRAM¹⁰

Memory

32 GB DDR4- 2400 SDRAM (2 X 16 GB)¹⁰
16 GB DDR4- 2400 SDRAM (1 x 16 GB)¹⁰
8 GB DDR4- 2400 SDRAM (1 x 8 GB)
8 GB DDR4- 2400 SDRAM (2 x 4 GB)¹⁰
4 GB DDR4- 2400 SDRAM (1 x 4 GB)

Memory Slots

2 SODIMM
Both slots are customer accessible / upgradeable
DDR4 PC4 SODIMMS, system runs at 2400
Supports Dual Channel Memory

10. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8822BE 802.11ac (2x2) Wi-Fi[®] and Bluetooth[®] 4.2 Combo¹¹
Realtek RTL8821CE 802.11ac (1x1) Wi-Fi[®] and Bluetooth[®] 4.2 Combo¹¹

Ethernet

Realtek RTL8111EP 10/100/1000 NIC¹²

11. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.

12. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Technical Specifications

AUDIO/MULTIMEDIA

Audio

Integrated Microphone (Mono or Dual Array)
2 Integrated Stereo Speakers

Speaker Power

2W/4ohm Per speaker

Camera

720p HD Camera⁷
720p HD Camera+IR Camera^{7,13}

Sensors

Accelerometer
Hall sensor

7. HD content required to view HD images.
13. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant with numeric keypad and optional backlit¹⁴
14. Backlit keyboard is an optional feature.

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

F1 - Display Switching
F2 - Blank
F3 - Brightness Down
F4 - Brightness Up
F5 - Audio Mute
F6 - Volume Down
F7 - Volume Up
F8 - Mic Mute
F9 - Blank or Backlit Toggle
F10 - Blank
F11 - Wireless
F12 - Sleep

Hidden Functions

Fn+R - Break
Fn+S - Sys Rq
Fn+C - Scroll Lock

Technical Specifications

SOFTWARE AND SECURITY

BIOS

HP BIOSphere Gen4¹⁵
HP DriveLock & Automatic DriveLock¹⁶
BIOS Update via Network
Secure Erase¹⁷
Absolute Persistence Module¹⁸
Pre-boot Authentication
HP Wireless Wakeup

Software

HP Native Miracast Support¹⁹
HP LAN-Wireless Protection
HP Connection Optimizer
HP 3D DriveGuard
HP Support Assistant²⁰
HP Noise Cancellation Software
HP Host Based MAC Address Manager
Buy Office (Sold separately)

Manageability Features

HP Driver Packs²¹
HP System Software Manager (SSM)
HP BIOS Config Utility (BCU)
HP Client Catalog
HP Manageability Integration Kit Gen3²²
HP Cloud Recovery²³

Client Security Software

HP Client Security Suite Gen4²⁴ including:
HP Security Manager²⁵ (including Credential Manager, HP Password Manager, HP Spare Key)
HP Power On Authentication
HP Fingerprint Sensor (select models)²⁹
Windows Defender²⁶

Security Management

Secure Erase¹⁷
TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)²⁷
SATA 0,1 port disablement (viaBIOS)
Serial, USB enable/disable (viaBIOS)
Power-on password (viaBIOS)
Setup password (viaBIOS)
Support for chassis padlocks and cable lock devices
Integrated hood sensor
HP Sure Click²⁸

15. HP BIOSphere Gen4 requires Intel® or AMD 8th Gen processors. Features may vary depending on the platform and configurations.

16. HP Drive Lock & Automatic Drive Lock is not supported on NVMe drives

17. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method.

18. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

Technical Specifications

<http://www.absolute.com/company/legal/agreements/> computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

19. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

20. HP Support Assistant requires Windows and Internet access.

21. HP Driver Packs not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>.

22. HP Manageability Integration Kit can be downloaded from

<http://www8.hp.com/us/en/ads/clientmanagement/overview.html>

23. HP Cloud Recovery is available for HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. Note: You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: <https://support.hp.com/us-en/document/c05115630>

24. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 7th or 8th generation processors.

25. HP Password Manager requires Internet Explorer or Chrome or Firefox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.

26. Windows Defender Opt In, Windows 10, and internet connection required for updates.

27. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).

28. HP Sure Click is available on most HP PCs and supports Microsoft® Internet Explorer and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.

29. HP Fingerprint Sensor is an optional feature and requires configuration at purchase.

POWER

Power Supply

HP Smart 65 W External AC power adapter³⁰

HP Smart 65 W EM External AC power adapter³⁰

HP Smart 65 W USB Type-C™ adapter³⁰

HP Smart 45 W External AC power adapter³⁰

HP Smart 45 W USB Type-C™ adapter³⁰

Primary Battery

HP Long Life 3-cell, 45 Wh Li-ion polymer³¹

Battery Life

Up to 13 hours and 45 minutes³²

Power Cord

3-wire plug - 1.8 m³⁰

3-wire plug - 1 m³⁰

2-wire plug - 1 m³⁰

Duckhead power cord - 1.0m³⁰

Duckhead power cord - 1.8m³⁰

Battery Weight

0.49 lb

0.22 kg

30. Availability may vary by country.

31. Battery is internal and not replaceable by customer. Serviceable by warranty.

32. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage.

See <http://www.bapco.com> for additional details.



Technical Specifications

WEIGHTS & DIMENSIONS

Weight

Starting at 4.41 lbs³³

Starting at 2 kgs³³

Dimensions (w x d x h)

14.37 x 10.11 x 0.75 in

36.49 x 25.69 x 1.9 cm

33. Weight will vary by configuration.

PORTS/SLOTS

Ports

1 USB 3.1 Type-C™ Gen 1 (Power delivery, DisplayPort™ 1.2)

2 USB 3.1 Gen 1

1 USB 2.0 (charging)

1 HDMI 1.4b³⁴

1 RJ-45

1 AC power

1 Headphone/Microphone Combo Jack

Expansion Slots

1 SD

Supports SD, SDHC, SDXC

34. HDMI cable sold separately.

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SERVICE AND SUPPORT

HP Services offers 3-year and 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to <http://www.hp.com/support/batterywarranty/> for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>.³⁵

35. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <http://www.hp.com/go/cpc>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

ENVIRONMENTAL & INDUSTRY

| | | | |
|--|---|---------------------|--|
| Eco-Label Certifications & declarations | This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: <ul style="list-style-type: none"> • IT ECO declaration • US ENERGY STAR® • EPEAT® Silver registered in the United States. See http://www.epeat.net for registration status in your country. • TCO Certified 8.0 | | |
| System Configuration | The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a Typically Configured Notebook. | | |
| Energy Consumption (in accordance with US ENERGY STAR® test method) | 115VAC, 60Hz | 230VAC, 50Hz | 100VAC, 50Hz |
| Normal Operation (Short idle) | 7.452 W | 7.620 W | 7.512 W |
| Normal Operation (Long idle) | 4.884 W | 5.052 W | 4.932 W |
| Sleep | 0.528 W | 0.576 W | 0.540 W |
| Off | 0.312 W | 0.336 W | 0.312 W |
| | Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system. | | |
| Heat Dissipation* | 115VAC, 60Hz | 230VAC, 50Hz | 100VAC, 50Hz |
| Normal Operation (Short idle) | 25 BTU/hr | 26 BTU/hr | 26 BTU/hr |
| Normal Operation (Long idle) | 17 BTU/hr | 17 BTU/hr | 17 BTU/hr |
| Sleep | 2 BTU/hr | 2 BTU/hr | 2 BTU/hr |
| Off | 1 BTU/hr | 1 BTU/hr | 1 BTU/hr |
| | Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour. | | |
| Declared Noise Emissions | Sound Power (L _{WAd} , bels) | | Sound Pressure (L _{pAm} , decibels) |

Technical Specifications

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| (in accordance with ISO 7779 and ISO 9296) | | | |
| Typically Configured – Idle | 2.7 | 14 | |
| Fixed Disk – Random writes | 3.1 | 14 | |
| Longevity and Upgrading | <p>This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:</p> <ul style="list-style-type: none"> • 3 USB ports • 2 SODIMM memory slots • Interchangeable HDD <p>Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.</p> | | |
| Batteries | <p>This battery(s) in this product comply with EU Directive 2006/66/EC</p> <p>Batteries used in the product do not contain:</p> <p>Mercury greater the 1ppm by weight Cadmium greater than 20ppm by weight</p> <p>Battery size: CR2032 (coin cell) Battery type: lithium/manganese dioxide</p> | | |
| Additional Information | <ul style="list-style-type: none"> • This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. • This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. • This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). • This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the Silver level, see http://www.epeat.net • Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. • This product contains 3% post-consumer recycled plastic (by wt.) • This product is 94.5% recycle-able when properly disposed of at end of life. | | |
| Packaging Materials | External: | PAPER/Corrugated | 295 g |
| | Internal: | PLASTIC/Polyethylene Expanded - EPE | 68 g |
| | | PLASTIC/Polyethylene low density - LDPE | 10 g |
| Material Usage | <p>This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):</p> <ul style="list-style-type: none"> • Asbestos • Certain Azo Colorants • Certain Brominated Flame Retardants – may not be used as flame retardants in plastics • Cadmium • Chlorinated Hydrocarbons • Chlorinated Paraffins • Formaldehyde • Halogenated Diphenyl Methanes • Lead carbonates and sulfates • Lead and Lead compounds | | |

Technical Specifications

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| | <ul style="list-style-type: none"> • Mercuric Oxide Batteries • Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. • Ozone Depleting Substances • Polybrominated Biphenyls (PBBs) • Polybrominated Biphenyl Ethers (PBBEs) • Polybrominated Biphenyl Oxides (PBBOs) • Polychlorinated Biphenyl (PCB) • Polychlorinated Terphenyls (PCT) • Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. • Radioactive Substances • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) |
| Packaging Usage | <p>HP follows these guidelines to decrease the environmental impact of product packaging:</p> <ul style="list-style-type: none"> • Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. • Eliminate the use of ozone-depleting substances (ODS) in packaging materials. • Design packaging materials for ease of disassembly. • Maximize the use of post-consumer recycled content materials in packaging materials. • Use readily recyclable packaging materials such as paper and corrugated materials. • Reduce size and weight of packages to improve transportation fuel efficiency. • Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards. |
| End-of-life Management and Recycling | <p>HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.</p> <p>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.</p> |
| HP Inc. Corporate Environmental Information | <p>For more information about HP's commitment to the environment:</p> <p>Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</p> |

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage

19V



Technical Specifications

| | |
|---|--|
| Average Operating Power | Windows 10 |
| Integrated graphics | Data is not available (APU 15W) |
| Max Operating Power | UMA < 45W |
| Temperature | |
| Operating | 32° to 95° F (0° to 35° C) |
| Non-operating | -4° to 140° F (-20° to 60° C) |
| Relative Humidity | |
| Operating | 10% to 90%, non-condensing |
| Non-operating | 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature |
| Shock | |
| Operating | 40 G, 2 ms, half-sine |
| Non-operating | 200 G, 2 ms, half-sine |
| Random Vibration | |
| Operating | 0.75 grms |
| Non-operating | 1.50 grms |
| Altitude (unpressurized) | |
| Operating | -50 to 10,000 ft (-15.24 to 3,048 m) |
| Non-operating | -50 to 40,000 ft (-15.24 to 12,192 m) |
| Planned Industry Standard Certifications | |
| UL | Yes |
| CSA | Yes |
| FCC Compliance | Yes |
| ENERGY STAR® | Selected models ³⁶ |
| EPEAT® 2019 | Yes, Silver in U.S. ³⁷ |
| ICES | Yes |
| Australia / | Yes |
| NZ A-Tick Compliance | Yes |
| CCC | Yes |
| Japan VCCI Compliance | Yes |
| KC | Yes |
| BSMI | Yes |
| CE Marking Compliance | Yes |
| BNCI or BELUS | Yes |
| CIT | Yes |
| GOST | Yes |
| Saudi Arabian Compliance (ICCP) | Yes |
| SABS | Yes |
| UKRSERTCOMPUTER | Yes |

36. Configurations of the HP ProBook 455R G6 that are ENERGY STAR® qualified are identified as HP ProBook 455R G6 ENERGY STAR on HP websites and on <http://www.energystar.gov>.

37. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit <http://www.epeat.net> for more information.

Technical Specifications

DISPLAYS

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

| | | |
|---|--|------------------------|
| Panel LCD 14 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45% NTSC 250 nits eDP slim | Outline Dimensions (W x H x D) | 316.17 x 197.98 (max) |
| | Active Area | 309.37 x 174.02 (typ.) |
| | Weight | 285 g (max) |
| | Diagonal Size | 14.0 inch |
| | Thickness | 3.0 mm (max) |
| | Interface | eDP 1.2 (2 lane) |
| | Surface Treatment | Anti-glare |
| | Touch Enabled | No |
| | Contrast Ratio | 600:1 (typ) |
| | Refresh Rate | 60 Hz |
| | Brightness | 250 nits |
| | Pixel Resolution | 1920 x 1080 (FHD) |
| | Format of LCD Pixel Arrangement | RGB |
| | Backlight | LED |
| | Color Gamut Coverage | 45% of NTSC |
| | Color Depth | 6 bits |
| Viewing Angle | UWVA 85/85/85/85 | |

| | | |
|---|--|-------------------------------|
| Panel LCD 15.6 inch diagonal FHD (1920x1080) Anti-Glare WLED UWVA 45% NTSC 220nits eDP slim NB | Outline Dimensions (W x H x D) | 350.96 x 216.75 (max) |
| | Active Area | 344.16 x 193.59 (typ) |
| | Weight | <370 g max. |
| | Diagonal Size | 15.6" |
| | Thickness | 3.2 mm max. |
| | Interface | eDP 1.2 |
| | Surface Treatment | Anti-glare |
| | Touch Enabled | No |
| | Contrast Ratio | 600:1 (typ) - AG |
| | Refresh Rate | 60 Hz |
| | Brightness | 220 nits typical (Panel Only) |
| | Pixel Resolution | 1920 x 1080 (FHD) |
| | Format of LCD Pixel Arrangement | RGB |
| | Backlight | LED |
| | Color Gamut Coverage | 45% of NTSC |
| | Color Depth | 6 bits + Hi FRC |
| Viewing Angle | UWVA 85/85/85/85 | |

Outline Dimensions (W x H x D) 350.96 x 216.75 (max)

Not all configuration components are available in all regions/countries.
c06263672 — DA 16402 - Worldwide — Version 12 — May 7, 2020

Technical Specifications

| | | |
|--|--|-------------------------------|
| Panel LCD 15.6 inch diagonal HD (1366x768) Anti-Glare WLED SVA 45% NTSC 220nits eDP 1.2 w/o PSR slim NB | Active Area | 344.16 x 193.59 (typ) |
| | Weight | <370 g max. |
| | Diagonal Size | 15.6" |
| | Thickness | 3.2 mm max. |
| | Interface | eDP 1.2 |
| | Surface Treatment | Anti-glare |
| | Touch Enabled | No |
| | Contrast Ratio | 300:1 (typ) |
| | Refresh Rate | 60 Hz |
| | Brightness | 220 nits typical (Panel Only) |
| | Pixel Resolution | 1366 x 768 (HD) |
| | Format of LCD Pixel Arrangement | RGB |
| | Backlight | LED |
| | Color Gamut Coverage | 45% of NTSC |
| Color Depth | 6 bits + Hi FRC | |
| Viewing Angle | SVA 40/40/15/30 | |

Technical Specifications

STORAGE AND DRIVES

HARD DRIVES

500 GB 7200 rpm
SATA Hard Drive

| | |
|------------------------------|--|
| Drive Weight | 0.20 lbs (92 g) ~ 0.21 lbs (95 g) |
| Rotation speed | 7200 rpm |
| Cache Buffer | Up to 32 MB |
| Height | 0.28 in (7 mm) |
| Width | 2.75 in (69.85 mm) |
| Interface | ATA-8, SATA 3.0 |
| Transfer Rate | 600 MB/s |
| Seek Time | Single Track: 2 ~ 1.5 ms Average: 11 ~ 13 ms Maximum: 18 ~ 22 ms |
| Logical Blocks | 976,773,168 |
| Operating Temperature | 32° to 140° F (0° to 60° C) [top cover temp] |
| Security Features | ATA Security |
| Features | S.M.A.R.T., NCQ, Ultra DMA |

1 TB 5400 rpm SATA Hard
Drive

| | |
|------------------------------|---|
| Drive Weight | 0.21 lbs (94 g) |
| Rotation speed | 5400 rpm |
| Cache Buffer | Up to 32 MB |
| Height | 0.28 in (7.2 mm) |
| Width | 2.75 in (69.85 mm) |
| Interface | ATA-8, SATA 3.0 |
| Transfer Rate | 600 MB/s |
| Seek Time | Single Track 2 ms Average 12 ~ 13 ms Maximum 18 ~ 22 ms |
| Logical Blocks | 1,953,525,168 |
| Operating Temperature | 32° to 140° F (0° to 60° C) [top cover temp] |
| Security Features | ATA Security |
| Features | S.M.A.R.T., NCQ, Ultra DMA |

SSD 128 GB 2280 M2
SATA-3 TLC

| | |
|---------------------------------|--|
| Form Factor | M.2 2280 |
| Capacity | 128 GB |
| NAND Type | TLC |
| Height | 0.09 in (2.3 mm) |
| Width | 0.87 in (22 mm) |
| Weight | 0.02 lb (10 g) |
| Interface | ATA-8, SATA 3.0 |
| Maximum Sequential Read | Up To 520 MB/s |
| Maximum Sequential Write | Up To 450 MB/s |
| Logical Blocks | 250,069,680 |
| Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] |

Technical Specifications

| | Features | DIPM; TRIM; DEVSLP |
|---|--|--|
| 256 GB 2280 PCIe NVMe Value Solid State Drive | Form Factor | M.2 2280 |
| | Capacity | 256 GB |
| | NAND Type | Value |
| | Height | 0.09 in (2.3 mm) |
| | Width | 0.87 in (22 mm) |
| | Interface | PCIe NVMe Gen 3 |
| | Maximum Sequential Read | Up To 1700 MB/s |
| | Maximum Sequential Write | Up To 1300 MB/s |
| | Logical Blocks | 500,118,192 |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] |
| | Features | TRIM; L1.2 |
| 512 GB 2280 M2 PCIe NVMe TLC Solid State Drive | Form Factor | M.2 2280 |
| | Capacity | 512 GB |
| | NAND Type | TLC |
| | Height | 0.09 in (2.3 mm) |
| | Width | 0.87 in (22 mm) |
| | Interface | PCIe NVMe Gen 3X4 |
| | Maximum Sequential Read | Up To 2600 MB/s |
| | Maximum Sequential Write | Up To 1400 MB/s |
| | Logical Blocks | 1,000,215,216 |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] |
| | Features | TRIM; L1.2 |
| SSD 512 GB 2280 PCIe NVMe Value | Form Factor | M.2 2280 |
| | Capacity | 512 GB |
| | NAND Type | Value |
| | Height | 0.09 in (2.3 mm) |
| | Width | 0.87 in (22 mm) |
| | Weight | 0.02 plb (10 g) |
| | Interface | PCIe NVMe Gen 3X4 |
| | Maximum Sequential Read | Up To 1700 MB/s |
| | Maximum Sequential Write | Up To 1500 MB/s |
| | Logical Blocks | 1,000,215,215 |
| Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |
| | Features | TRIM; L1.2 |

Technical Specifications

NETWORKING/COMMUNICATIONS

WLAN

| | | |
|--|------------------------------------|---|
| Realtek 802.11a/b/g/n/ac (2x2) WiFi® and Bluetooth® 4.2 Combo¹ | Wireless LAN Standards | IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac |
| | Interoperability | Wi-Fi® certified |
| | Frequency Band | 802.11b/g/n • 2.402 – 2.482 GHz 802.11a/n/ac • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz |
| | Data Rates | <ul style="list-style-type: none"> • 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) • 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz) |
| | Modulation | Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM |
| | Security³ | <ul style="list-style-type: none"> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • IEEE 802.11i • WAPI |
| | Network Architecture Models | Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) |
| | Roaming | IEEE 802.11 compliant roaming between access points |
| | Output Power² | <ul style="list-style-type: none"> • 802.11b: +14dBm minimum • 802.11g: +12dBm minimum • 802.11a: +12dBm minimum • 802.11n HT20(2.4GHz): +12dBm minimum • 802.11n HT40(2.4GHz): +12dBm minimum • 802.11n HT20(5GHz): +10dBm minimum • 802.11n HT40(5GHz): +10dBm minimum • 802.11ac VHT80(5GHz): +10dBm minimum |
| | Power Consumption | Transmit mode 2.0 W Receive mode 1.6 W Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated) Connected Standby 10 mW Radio disabled 8 mW |
| | Power Management | ACPI and PCI Express compliant power management 802.11 compliant power saving mode |

Technical Specifications

| | |
|---|--|
| Receiver Sensitivity³ | 802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum |
| Antenna type | High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications |
| Form Factor | PCI-Express M.2 MiniCard |
| Dimensions | Type 2230: 2.3 x 22.0 x 30.0 mm |
| Weight | Type 2230: 2.8g |
| Operating Voltage | 3.3v +/- 9% |
| Temperature | Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C) |
| Humidity | Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing) |
| Altitude | Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m) |
| LED Activity | LED Amber – Radio OFF; LED White – Radio ON |

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

| | |
|--|---|
| Bluetooth Specification | 4.0/4.1/4.2 Compliant |
| Frequency Band | 2402 to 2480 MHz |
| Number of Available Channels | Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH) |
| Signaling Data Rate⁴ | Legacy: 3 Mbps signaling data rate ¹ 2.17 Mbps BLE: 1 Mbps signaling data rate ¹ 0.2 Mbps 1. Actual throughput may vary. |
| Transmit Power | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR. |
| Power Consumption | Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW |
| Electrical Interface | USB 2.0 compliant |
| Bluetooth Software Supported | Microsoft Windows Bluetooth Software |
| Link Topology | |
| Power Management | Microsoft Windows ACPI, and USB Bus Support |



Technical Specifications

| | |
|--|--|
| Certifications | FCC (47 CFR) Part 15C, Section 15.247 & 15.249 |
| Power Management Certifications | ETS 300 328, ETS 300 826 Low Voltage Directive IEC950UL, CSA, and CE Mark |
| Bluetooth Profiles Supported | BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) |

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
4. Actual throughput may vary

| | | |
|--|-------------------------------|---|
| Realtek 802.11a/b/g/n/ac (1x1) WiFi® and Bluetooth® 4.2 Combo¹ | Wireless LAN Standards | IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac |
| | Interoperability | Wi-Fi® certified |
| | Frequency Band | 802.11b/g/n • 2.402 – 2.482 GHz 802.11a/n • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz |
| | Data Rates | • 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) • 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz) |
| | Modulation | Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM |
| | Security³ | • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware |

Technical Specifications

| | |
|---|---|
| | <ul style="list-style-type: none"> • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • IEEE 802.11i • WAPI |
| Network Architecture Models | Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) |
| Roaming | IEEE 802.11 compliant roaming between access points |
| Output Power² | <ul style="list-style-type: none"> • 802.11b: +14dBm minimum • 802.11g: +12dBm minimum • 802.11a: +12dBm minimum • 802.11n HT20(2.4GHz): +12dBm minimum • 802.11n HT40(2.4GHz): +12dBm minimum • 802.11n HT20(5GHz): +10dBm minimum • 802.11n HT40(5GHz): +10dBm minimum • 802.11ac VHT80(5GHz): +10dBm minimum |
| Power Consumption | Transmit mode 2.0 W Receive mode 1.6 W Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated) Connected Standby 10 mW Radio disabled 8 mW |
| Power Management | ACPI and PCI Express compliant power management 802.11 compliant power saving mode |
| Receiver Sensitivity³ | 802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum |
| Antenna type | High efficiency antenna. One embedded dual band 2.4/5 GHz antenna is provided to the card to support WLAN communications and Bluetooth communications |
| Form Factor | PCI-Express M.2 MiniCard |
| Dimensions | Type 2230: 2.3 x 22.0 x 30.0 mm |
| Weight | Type 2230: 2.8g |
| Operating Voltage | 3.3v +/- 9% |
| Temperature | Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C) |
| Humidity | Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing) |
| Altitude | Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m) |
| LED Activity | LED Amber – Radio OFF; LED White – Radio ON |

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

| | |
|--------------------------------|-----------------------|
| Bluetooth Specification | 4.0/4.1/4.2 Compliant |
| Frequency Band | 2402 to 2480 MHz |

Not all configuration components are available in all regions/countries.
c06263672 — DA 16402 - Worldwide — Version 12 — May 7, 2020



Technical Specifications

| | |
|--|--|
| Number of Available Channels | Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH) |
| Signaling Data Rate¹ | Legacy: 3 Mbps signaling data rate ¹ 2.17 Mbps BLE: 1 Mbps signaling data rate ¹ 0.2 Mbps 1. Actual throughput may vary. |
| | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels |
| | Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) |
| Transmit Power | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR. |
| Power Consumption | Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW |
| Electrical Interface | USB 2.0 compliant |
| Bluetooth Software Supported | Microsoft Windows Bluetooth Software |
| Link Topology | |
| Power Management | Microsoft Windows ACPI, and USB Bus Support |
| Certifications | FCC (47 CFR) Part 15C, Section 15.247 & 15.249 |
| Power Management Certifications | ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark |
| Bluetooth Profiles Supported | BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP) ² Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) |

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
4. Actual throughput may vary

Technical Specifications

| | | |
|--|-----------------------------|---|
| Realtek RTK8111HSH 10/100/1000 Integrated NIC | Connector | RJ-45 |
| | System Interface | PCIe + SMBus |
| | Data rates supported | 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet) |
| | Power Management | ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption |
| | Performance Features | TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K |
| | Manageability | Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status |
| | Management Interface | Auto MDI/MDIX Crossover cable detection |

Technical Specifications

POWER

| | | | | |
|--------------------------------------|---|---|--------------------------------------|-----|
| HP 45 W Smart AC adapter | Dimensions (H x W x D) | 3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm) | | |
| | Weight | 0.386 lb (175g) max | | |
| | Input | Input | 90 to 265 VAC | |
| | | Input Efficiency | 87.74% at 115Vac and 88.4% at 230Vac | |
| | | Input frequency range | 47 to 63 Hz | |
| | | Input AC current | 1.4 A at 90 VAC | |
| | | Output | Output power | 45W |
| | | DC output | 19.5V | |
| | | Hold-up time | 5 msec at 115 VAC input | |
| | | Output current limit | <8.0A | |
| | Connector | 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords | | |
| | Environmental Design | Operating temperature | 32° F to 95° F (0° to 35° C) | |
| | | Non-operating (storage) temperature | -4° F to 185oF (-20o to 85° C) | |
| | | Altitude | 0 to 16,400 ft (0 to 5,000 m) | |
| | | Humidity | 20% to 95% | |
| Storage Humidity | | 10% to 95% | | |
| EMI and Safety Certifications | <p>*CE Mark - full compliance with LVD and EMC directives</p> <p>* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.</p> <p>* MTBF - over 200,000 hours at 25°C ambient condition.</p> | | | |

| | | | | | |
|-------------------------------------|-----------------------------|---|---|-------|--|
| HP 65 W Smart AC adapter | Dimensions | 90 x 51 x 28.5mm | | | |
| | Weight | unit: 220g +/- 10g | | | |
| | Input | Input Efficiency | 88% min at 115 VAC and 89% min at 230 VAC | | |
| | | Input frequency range | 47 to 63 Hz | | |
| | | Input AC current | 1.7 A at 90 VAC | | |
| | | Output | Output power | 65W | |
| | | | DC output | 19.5V | |
| | | Hold-up time | 5 msec at 115 VAC input | | |
| | | Output current limit | <11.0A | | |
| | Connector | 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords | | | |
| | Environmental Design | Operating temperature | 32° F to 95° F (0° to 35° C) | | |
| | | Non-operating (storage) temperature | -4° F to 185° F (-20° to 85° C) | | |
| | | Altitude | 0 to 16,400 ft (0 to 5000m) | | |



Technical Specifications

| | | |
|--------------------------------------|---|------------|
| EMI and Safety Certifications | Humidity | 20% to 95% |
| | Storage Humidity | 10% to 95% |
| | <p>*CE Mark - full compliance with LVD and EMC directives</p> <p>* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.</p> <p>* MTBF - over 200,000 hours at 25°C ambient condition.</p> | |

| | | | |
|--------------------------------------|---|--|---|
| HP 65 W EM Smart AC adapter | Dimensions | 102 x 55 x 30mm | |
| | Weight | 270g +/- 10g | |
| | Input | Input Efficiency | 87% min at 115V/230V |
| | | Input frequency range | 47 to 63 Hz |
| | | Input AC current | 1.7 A at 90 VAC and maximum load |
| | | DC output | 65 W(19.5V/3.33A) |
| | | Hold-up time | 5 msec at 115 VAC input |
| | | Output current limit | <11A, Over voltage protection- 29V max automatic shutdown |
| | | Connector | 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords |
| | Environmental Design | Operating temperature | 0° to 35° C |
| | | Non-operating (storage) temperature | -20° to 85° C |
| | | Altitude | 0 to 5,000 m |
| | | Humidity | 0% to 95% |
| Storage Humidity | | 0% to 95% | |
| EMI and Safety Certifications | <p>*CE Mark - full compliance with LVD and EMC directives</p> <p>* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.</p> <p>* MTBF - over 200,000 hours at 25°C ambient condition.</p> | | |

| | | | |
|--|-------------------|------------------------------|--|
| AC Adapter 65 W nPFC USB type C | Dimensions | 74 x 74 x 28.5mm | |
| | Weight | unit: 245g +/- 10g | |
| | Input | Input Efficiency | 81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A |
| | | Input frequency range | 47 to 63 Hz |
| | | Input AC current | 1.7 A at 90 VAC and maximum load |
| | | Output power | 65W |
| | | DC output | 5V/9V/10V/12V/15V/20V |



Technical Specifications

| | | |
|--------------------------------------|--|--|
| | Hold-up time | 5ms at 115 Vac input |
| | Output current limit | <8.0A |
| Connector | | Type C |
| Environmental Design | Operating temperature | 32°F to 95°F (0° to 35°C) |
| | Non-operating (storage) temperature | -4°F to 185°F (-20° to 85°C) |
| | Altitude | 0 to 16,400 ft (0 to 5000m) |
| | Humidity | 0% to 95% |
| | Storage Humidity | 0% to 95% |
| EMI and Safety Certifications | | *CE Mark - full compliance with LVD and EMC directives |
| | | * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. |
| | | * MTBF - over 200,000 hours at 25°C ambient condition. |
| | | |

| | | | |
|--|-----------------------------|--|---|
| AC Adapter 45 W nPFC USB type C | Dimensions | 62.0 x 62.0 x 28.5mm | |
| | Weight | unit: 220g +/- 10g | |
| | Input | Input Efficiency | Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec:5V: 81.5%9V: 86.7%10V: 87.5%12V: 87.8%15V: 87.8%20V: 87.8% |
| | | Input frequency range | 47 to 63 Hz |
| | | Input AC current | Max. 1.4 A at 90 Vac |
| | | Output power | 5V/15W 9V/27W 10V/37.5W 12V/45W 15V/45W 20V/45W |
| | | DC output | 5V/9V/10V/12V/15V/20V |
| | | Hold-up time | 5ms at 115 Vac input |
| | | Output current limit | <5.0A |
| | Connector | | Type C |
| | Environmental Design | Operating temperature | 32° F to 95° F (0° to 35° C) |
| | | Non-operating (storage) temperature | -4° F to 185° F (-20° to 85° C) |
| | | Altitude | -4° F to 185° F (-20° to 85° C) |
| | | Humidity | 20% to 95% |
| | | Storage Humidity | 10% to 95% |
| EMI and Safety Certifications | | *CE Mark - full compliance with LVD and EMC directives | |
| | | * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. | |



Technical Specifications

* MTBF - over 200,000 hours at 25°C ambient condition.

| | | |
|--|--|-------------------------------|
| 3 Cell WHr 45 Long Life - Polymer HP Fast Charge Technology¹ | Dimensions (H x W x L) | 6.0. x 184.7 x 88.9 mm |
| | Weight | 0.22 kg (0.48lb) |
| | Cells/Type | 3cell Lithium-Ion |
| | Energy | |
| | Voltage | 11.55 V |
| | Amp-hour capacity | 3.900Ah |
| | Watt-hour capacity | 45Wh |
| | Temperature | |
| | Operating (Charging) | 32° to 113° F (0° to 45° C) |
| | Operating (Discharging) | 14° to 122° F (-10° to 60° C) |
| | Optional Travel Battery Available | No |

1. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.

Options and Accessories (sold separately and availability may vary by country)

| Type | Description | Part Number |
|-------------------------------|---|-------------|
| Cases | HP Essential Top Load Case | H2W17AA#xxx |
| | HP Essential Backpack (up to 15.6") | H1D24AA |
| | HP Essential Messenger Case (up to 17.3") | H1D25AA |
| Docking | HP USB-C Mini Dock | 1PM64AA#xxx |
| | HP USB-C Universal Dock | 1MK33AA#xxx |
| | HP USB-C Dock G4 | 3FF69AA#xxx |
| | HP TB Dock 120W w/Audio | 3YE87AA#xxx |
| | HP Thunderbolt Dock 120W G2 | 2UK37AA#xxx |
| | HP TB Dock G2 w/ Combo Cable | 3TR87AA#xxx |
| | HP TB Dock 120W G2 Cable | 3XB94AA |
| | HP TB Dock G2 Combo Cable | 3XB96AA |
| | HP TB Dock G2 Audio Module | 3AQ21AA |
| | HP USB Travel Dock | TOK30AA#xxx |
| DIB HP 400G6 HDD Bracket Kit | 5LV47AV | |
| Input/Output | HDMI to VGA Adapter | H4F02AA |
| | HP USB-C to HDMI 2.0 Adapter | 1WC36AA |
| | HP USB-C to VGA Adapter | N9K76AA |
| | HP USB Essential Keyboard and Mouse | H6L29AA |
| | HP Ultra Mobile Wireless Mouse | H6F25AA#xxx |
| | HP Comfort Grip Wireless Mouse | H2L63AA |
| | HP 3-Button USB Laser Mouse | H4B81AA |
| | HP USB Travel Mouse | G1K28AA |
| HP USB Collaboration Keyboard | Z9N38AA#xxx | |
| UCC | HP UC Speaker Phone | 4VW02AA |
| | HP Stereo 3.5 mm Headset | T1A66AA |
| | HP Stereo USB Headset | T1A67AA |
| Power | HP Power Bank | N9F71AA#xxx |
| | HP 45W LC USB-C Power Adapter | 1MZ01AA#ABA |
| | HP 45W Smart AC Adapter 4.5mm | H6Y88AA#xxx |
| | HP 65W Slim AC Adapter | H6Y82AA#xxx |
| | HP 65W USB-C Power Adapter | 3PN48AA |
| | HP 45W USB-C Power Adapter | 1HE07AA#xxx |
| | HP 65W USB-C Power Adapter | 1HE08AA#xxx |
| | HP USB-C Power Bank | 2NA10AA#xxx |
| Storage | HP External USB Optical Drive | F2B56AA |
| | HP 500GB 7200rpm HDD | F3B97AA |
| | HP 512GB TLC PCI-e 3x4 NVMe SSD (2280) | 1FU88AA |

Options and Accessories (sold separately and availability may vary by country)

| | | |
|-----------------|--|---------|
| Memory | 4GB 2666MHz DDR4 | 4VN05AA |
| | 8GB 2666MHz DDR4 | 4VN06AA |
| | 16GB 2666 MHz DDR4 | 4VN07AA |
| Security | HP Essential Keyed Cable lock 12.3mm | T0Y14AA |
| | HP Keyed Cable Lock 10mm | T1A62AA |
| | HP UltraSlim Keyed Cable Lock | T1A62AA |
| Displays | HP ProDisplay P240va 23.8 inch Monitor | N3H14AA |
| | HP ProDisplay P232 23 inch Monitor | K7X31AA |
| | HP EliteDisplay E223 21.5 inch Monitor | 1FH45AA |
| | HP EliteDisplay E243 23.8-inch Monitor | 1FH47AA |
| | HP EliteDisplay S14 14-inch Portable Display | 3HX46AA |

Summary of Changes

| Date of change: | Version History: | | Description of change: |
|------------------------|-------------------------|---------|--|
| May 7, 2019 | V1 to V2 | Added | Environmental section, Updated at a glance section |
| June 10, 2019 | V2 to V3 | Added | HP Cloud Recovery |
| July 17, 2019 | V3 to V4 | Updated | Processor |
| July 24, 2019 | V4 to V5 | Updated | Color Gamut Format |
| July 25, 2019 | V5 to V6 | Added | Speaker to Audio Section |
| September 20, 2019 | V6 to V7 | Updated | Lock Slot and 250 nits Panel |
| October 11, 2019 | V7 to V8 | Added | DisplayPort™ 1.2 |
| November 21, 2019 | V8 to V9 | Updated | Longevity and Upgrading section |
| November 26, 2019 | V9 to v10 | Added | Processor Ryzen 3700U |
| February 27, 2020 | V10 to V11 | Updated | Copyright and footnote for fingerprint sensor |
| May 7, 2020 | V11 to V12 | Added | Ethernet in networking section |
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